E.G.S. PILLAY ENGINEERING COLLEGE (Autonomous)

Approved by AICTE, New Delhi | Affiliated to Anna University, Chennai Accredited by NAAC with 'A'Grade | Accredited by NBA

NAGAPATTINAM-611002



M.E. MANUFACTURING ENGINEERING

REGULATION -2021

First Year – First Semester

Course	Course Code	Course Name	L	Т	Р	C	Maxi	imum	Marks
Category	Course Coue		L	1	1	C	CA	ES	Total
Theory Cou	rse								
FC	2101MF101	Probability and Statistics in Manufacturing	3	2	0	4	40	60	100
PCC	2102MF102	Modern Manufacturing Processes	3	0	0	3	40	60	100
PEC	2103MF001	Program Elective–I(Theory of Metal Forming)	3	0	0	3	40	60	100
PEC	2103MF007	Program Elective–II (Advanced Welding Technology)	3	0	0	3	40	60	100
RMC	2101RMX01	Research Methodology and IPR	3	0	0	3	40	60	100
AC		Audit Course – I	2	0	0	0	0	0	0
Laboratory	Course								
PCC	2102MF103	Computer Aided Manufacturing Laboratory	0	0	4	2	50	50	100
РСС	2102MF104	Metal Forming and Metal Testing Laboratory	0	0	4	2	50	50	100
Total			17	2	8	20	300	400	700

2101MF101		PROBABILITY AND STATISTICS IN	L	Т	Р	С
21011917 101		MANUFACTURING	3	1	0	4
COURSE OBJE	CTIVE	 To understand the basics of random variables with enstandard discrete and continuous distributions. To introduce the concepts of sampling distributions a To provide an understanding of the statistical method by which real life problems are analyzed. To analyze various data using statistical techniques. To train the students in design experiments and use th research. 	and the te ds and co	eststa oncept	tistics ts	.
MODULE 1	PROBAI	BILITY THEORY]	12 Ho	ours
	al, Poisson	ability density and distribution functions-moment generating, Normal distributions and their applications in manufacturing	•			
MODULE 2		NG THEORY			12 Ho	ours
		dard error - t, F, Chi square distributions - applications in ma	anufactur			
MODULE 3		TION THEORY			12 Ho	ours
		tion mean, standard deviation, difference in means, preparation ications in manufacturing.	on ratio c	of star	ndard	
MODULE 4	TESTIN	G OF HYPOTHESIS AND ANOVA		1	12 Ho	ours
		mples – Tests concerning proportion, means, standard deviatio n test -Design of experiments - applications in manufacturing.		s base	ed on	
MODULE 5	ANOVA]	12 Ho	ours
Design of experime	ents – One,	Two factor Models- applications in manufacturing				
			Total:	(50 He	ours
COURSE OUTC	or cc Cu Cu m Cu ar	 O1: Formulate and find optimal solution in optimizing/allocation/assignment problems involving conditionstraints. O2: Simulate appropriate application/distribution problems. O3: Obtain the value of the point estimators using the metho ethod of maximum likelihood. O4: Apply the concept of various test statistics used in hypothed variances of large and small samples. O5: Get exposure to the principal component analysis of randomication. 	ions and od of mon esis testir dom vecto	nents ng for ors ar	and mear	
REFERENCES		 Jay L.Devore, "Probability an Statistics for Engineering Sciences", Cengage Learning, 9th Edition, Boston, 2016 Johnson, R.A, Irwin Miller and John Freund., "Miller an Probability and Statistics for Engineers", Pearson Educa New York,2016. Johnson, R.A., and Wichern, D.W., "Applied Multivaria Analysis", Pearson Education, Sixth Edition, New Delhi 4. Ross. S.M., "Probability Models for Computer Science" Press, SanDiego, 2002. Taha H.A., "Operations Research: An Introduction", Pr 	5. ad Freund ation, 9 th ate Statist i, 2013. ', Acaden	d's Editi tical nic		Pvt.

		L	Т	Р	C
2102MF102	MODERN MANUFACTURING PROCESSES	3	0	0	3
COURSE OBJECTIVI			1		
	• To understand electrical and electrochemical machining proc	cesses.			
	• To analyses the principles of high energy aided machining.				
	• To study the surface and bulk machining processes of silicon	n wafer.			
	• To introduce students to the major manufacture steps in elec	tronic c	ircuit	board	s.
MODULE 1	ABRASIVE AIDED MACHINING PROCESSES			91	Hours
– water jet machining -	ter jet machining - ultrasonic machining – Abrasive flow machining- Abrasive flow machining – Abrasive flow machining- Magneto rheolo vorking principle – steps - types – process parameters – derivations – process – derivations – process parameters – derivations – process – derivations – derivations – derivations – process – derivations – derivations – process – derivations – derivation	ogical A	Abrasi	ve flo	ow
MODULE 2 EI	LECTRICAL AND CHEMICAL AIDED MACHINING PROCESS	SES		91	Hours
Electrochemical grinding applications. Hybrid Mac	-			nd	
	IGH ENERGY AIDED MACHINING PROCESSES				Hours
	 Electron beam machining – Plasma arc machining – Ion beam mac process parameter – derivations – problems, merits, demerits and appli 	•		istruc	uon
		cutions.			
	ABRICATION OF MICRO DEVICES				Hours
	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching				
Semiconductors – Si waf – surface and bulk machin	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching			on – b	
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching - hing – LIGA Process	– metal	lizatio	on – b 9 1	onding
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching hing – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro	– metal	lizatio	on – b 9 1	onding Hours
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching hing – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro	– metal onic mat nology Total:	lizatio terial	on – b 9 1 and	onding Hours
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching hing – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology	– metal onic mat nology Total:	lizatio terial	on – b 9 1 and	onding Hours
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching hing – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology CO1 : Understand and grasp the significance of modern machining pro applications. CO2 : Identify the selection of machining process and its parameters.	– metali onic mat nology Total: ocess an	lizatio terial d its	on – b 9 1 and	onding Hours
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching ming – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology – Solid free form fabrication -SAW devices, Surface Mount Technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology – Solid free form fabrication -SAW devices, Surface Mount Technologies and applications. CO1 : Understand and grasp the significance of modern machining process and its parameters. CO2 : Identify the selection of machining process and its parameters. CO3 : Express and appreciate the cutting edge technologies and apply	– metali onic mat nology Total: ocess an	lizatio terial d its	on – b 9 1 and	ondinį Hours
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Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr COURSE OUTCOME	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching ming – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology – Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication for the selection of machining process and its parameters. CO2 : Identify the selection of machining process and its parameters. CO3 : Express and appreciate the cutting edge technologies and apply research purposes. CO4 : Measure the stages involved in fabrication of micro devices. CO5 : Create new devices involved in micro fabrication and recent technologies	– metal onic mat nology Total: ocess an the sam	lization terial d its ne for	on – b 9 1 and	ondinį Hours
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching ming – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology – Solid free form fabrication -SAW devices, Surface Mount Technology - Interventional devices and applications. CO1 : Understand and grasp the significance of modern machining properties and applications. CO2 : Identify the selection of machining process and its parameters. CO3 : Express and appreciate the cutting edge technologies and apply research purposes. CO4 : Measure the stages involved in fabrication of micro devices. CO5 : Create new devices involved in micro fabrication and recent tect 1. Brahem T. Smith, Advanced Machining I.F.S. UK 2016. 2. Jaeger R.C., Introduction to Microelectronic Fabrication Addison V	- metal onic mat nology Total: ocess an the sam	lization terial d its ne for y.	on – b 9 1 and 5 Hou	onding Hours Irs
Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr COURSE OUTCOME	ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching ming – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technology – Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technology - Solid free form fabrication -SAW devices, Surface Mount Technologies, CO1 : Understand and grasp the significance of modern machining process and its parameters. CO2 : Identify the selection of machining process and its parameters. CO3 : Express and appreciate the cutting edge technologies and apply research purposes. CO4 : Measure the stages involved in fabrication of micro devices. CO5 : Create new devices involved in micro fabrication and recent technologies involved in micro fabrication and recent technologies. 1. Brahem T. Smith, Advanced Machining I.F.S. UK 2016. 2. Jaeger R.C., Introduction to Microelectronic Fabrication Addison Mapple.	- metal onic mat nology Total: ocess an the sam	lization terial d its ne for y.	on – b 9 1 and 5 Hou	ondin Hours
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Semiconductors – Si waf – surface and bulk machin MODULE 5 M Molding – PCB board hy processing– stereo lithogr COURSE OUTCOME	 ABRICATION OF MICRO DEVICES Fer - planarization – Oxidation - diffusion – ion implantation – etching hing – LIGA Process ICROFABRICATION TECHNOLOGY brid and MCM technology – programmable devices and ASIC – electro aphy – Solid free form fabrication -SAW devices, Surface Mount Technologies and grasp the significance of modern machining pro applications. CO2 : Identify the selection of machining process and its parameters. CO3 : Express and appreciate the cutting edge technologies and apply research purposes. CO4 : Measure the stages involved in fabrication of micro devices. CO5 : Create new devices involved in micro fabrication and recent tection of the stages involved in micro fabrication Addison V 1998. Jain V K, Micromanufacturing Processes, CRC Press, 2012. Julian W. Gardner, Vijay K Varadan and Osama O Awadelkarim, 	- metal onic mat nology Total: ocess an the sam chnolog Wesley, Micros	lizatio lizatio terial d its ne for y. 2ndE ensor	on – b 9 1 and 5 Hou dition	onding Hours Irs

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2101RMX01		RESEARCH METHODOLOGY AND IPR		3 (0	3
COURSE OBJ	ECTIVE	 Problem formulation, analysis and solutions. Technical paper writing / presentation without viol Patent drafting and filing patents. 	ating profess	ional e	thic	s	
MODULE 1	RESEARCH	PROBLEM FORMULATION		9	Ног	urs	
electing a resear	ch problem, s	Sources of research problem, criteria characteristics of a good scope and objectives of research problem. Approaches of in n, analysis, interpretation, necessary					
MODULE 2	LITERATU	RE REVIEW		9	Ноі	urs	
Effective literatur	re studies appr	oaches, analysis, plagiarism, and research ethics.					
MODULE 3	TECHNICA	LWRITING /PRESENTATION		9	Hou	urs	
	0.	v to write report, paper, developing a research proposal, forma a review committee.	at of research	propo	sal,	a	
MODULE 4	INTRODUC	TION TO INTELLECTUAL PROPERTY RIGHTS (IPR)	9	Ног	urs	
MODULE 5		for grants of patents, Patenting under PCT.					
		TUAL PROPERTY RIGHTS (IPR)			Hou		
Patent Rights: S Geographical Ind Computer Softwa	Cope of Pate ications. New re etc.			and	latal	base	
Patent Rights: S Geographical Ind Computer Softwa	Cope of Pate ications. New re etc.	FUAL PROPERTY RIGHTS (IPR) ent Rights. Licensing and transfer of technology. Patent p Developments in IPR: Administration of Patent System,		and ogical	latal Sys	base	s,
Patent Rights: S Geographical Ind Computer Softwa	Come of Pate ications. New re etc. edge Case Stu	FUAL PROPERTY RIGHTS (IPR) ent Rights. Licensing and transfer of technology. Patent p Developments in IPR: Administration of Patent System,	IPR of Biol Total : uter, informa	and ogical	latal Sys	base stem	s,

PROGRAM ELECTIVE-I

			L	Т	Р	С
2103MF001		THEORY OF METAL FORMING	3	0	0	3
MODULE 1	THEORY	Y OF PLASTICITY			9	Hours
representation of	a state of	on – Yield criteria – Tresca and Von-Mises – Distortion energy – Stress- stra stress – cylindrical and spherical co-ordinate system – upper and lower loons in Metal Forming analysis.				
MODULE 2	THEORY	Y AND PRACTICE OF BULK FORMING PROCESSES			9	HOURS
calculation of for Rolling, Extrusion	ces, work n and Drav	nation in Forging, Rolling, Extrusion, rod/wire drawing and tube drawing done – Process parameters, equipment used – Defects – applications – Re wing processes – Design consideration in forming.	0		es in	Forging,
		METAL FORMING				Hours
– Hydro forming application – Incre	- Stretch	ventional processes – High energy rate forming (HERF) techniques – Superforming – Water hammer forming – Principles and process parameters – A brming.			imitat	ions and
MODULE 4	POWDE	R METALLAURGY AND SPECIAL FORMING PROCESSES			9	Hours
MODULE 5	SURFAC	LASER beam forming CE TREATMENT AND METAL FORMING APPLICATIONS evaluation of friction in metal forming selection – influence of temperatulation	ire an	d glid		Hours elocity –
Friction heat gene forming, Extrusio	eration – F n, hot and cal regime	riction between metallic layers – Lubrication carrier layer – Surface treatmen cold forging. Processing of thin Al tapes – Cladding of Al alloys – Duplex s of Ti and Al alloys during deformation – Formability of welded blank she	nt for and t et – I	drawin triplex Laser s	ng, sho steel structu	eet metal rolling – red steel
			ТО	TAL:	45 H	lours
REFERENCES		 Altan T, Metal forming – Fundamentals and applications – American S Metalspark,1983. Helmi A Youssef, Hassan A. El-Hofy, Manufacturing Technology: Ma andEquipment, CRC publication press, 1stEdition,2017. Marciniak Z, Duncan J.L, Hu S.J, Mechanics Forming, Butterworth-Heinemann,2ndEdition, 2002. Nagpal G.R, Metal Forming Processes, Khanna publishers, 2005. Shiro Kobayashi, Soo-Ik-Oh-Altan T, Metal forming and Finite Element UniversityPress,1989. Surender kumar, Technology of Metal Forming Processes, Prentice Ha Publishers,1st Edition,2008. 	terials of nt Me	s, Proc Sheet thod, 9	cesses M	etal d

PROGRAM ELECTIVE-II

			L	Т	P	C
2103MF007		ADVANCED WELDING TECHNOLOGY	3	0	0	3
MODULE 1	ARC A	ND GAS WELDING PROCESSES				9 Hours
Submerged Arc W Limitations and A	Velding, Applicat	Air Acetylene Welding, Oxyacetylene Welding, Carbon Arc Welding, TIG and MIG Welding, Plasma Arc Welding and Electro slag We ions - Spot Welding, Seam Welding, Projection Welding, Resistant ing and High Frequency Resistance Welding Processes – Advantages, I	lding H ce Bu	Proces tt We	sses– A lding,	Advantages, Flash Butt
MODULE 2	SOLID	STATE AND SPECIAL WELDING PROCESSES			9) Hours
Welding, Roll We Atomic Hydroger	elding an Neldi	Bonding, Explosive Welding, Ultrasonic Welding, Friction Welding, nd Hot Pressure Welding Processes – Advantages, Limitations and App ng, Electron Beam Welding, Laser Beam Welding, Friction Stir We verospace, Nuclear and Surface Transport Vehicles.	olicatio	ns - 7	hermi	te Welding,
MODULE 3	WELD	ING METALLURGY			9	Hours
columnar structure reactions, Phase tr steels, welding of alloys – processes,	es and g ansform stainles difficul nce - re	, preheat, significance of thermal severity number, Epitaxial growth growth morphology effect of welding parameters - absorption of gas nations- weld CCT diagrams-carbon equivalent-preheating and post he s steels use of Schaffer and Delong diagrams, welding of cast irons - lties, microstructures, defects and remedial measures, Origin - types -pr medial measures, Hot cracking - cold cracking -lamellar tearing - rehe trameters,.	es - ga ating w Weldin ocess i	as/me /eld a ng of nduce	tal and bility o Cu, A ed	d slag/metal of low alloy l, Ti and Ni
MODULE 4	DESIG	N OF WELDMENTS				9 Hours
loading, Permissib for statically loade – stress, concentra stress intensity fac testing, applicatio measurements - th	le stress d structu tions - f tors - Ll n of fi hermal a	ency, factor of safety, symbols, selection of edge preparation, design s, allowable defects, computation of stresses in welds, weld size calcu- ures - Design for fluctuating and impact loading - dynamic behavior of atigue analysis fatigue improvement techniques - permissible stress- li EFM and EPFM concepts - brittle fracture- transition, temperature appr facture mechanics to fatigue Welding residual stresses - causes, nd mechanical relieving; types of distortion - factors affecting distort on - correction, jigs, fixtures and positioners	ilation, joints fe pred oach - occurr	code ictior fractu ence,	requin , Conc are toug effect	rement cept of ghness
MODULE 5	WELD	ING DEFECTS AND INSPECTION			9	Hours
welding processes welds of other we	. Resista elding 1	fects- General sources of weld defects- Arc welding defects- Weld of ance welding defects- Defects in Friction welding- Defects in friction processes-Visual Inspection-Liquid Penetrant Inspection- Magnetic p raphy testing (RT) - Eddy current testing –Thermography- Optical an	stir we article	elding insp	- Defection-	ects in
		c	OTAI		45 Ho	urs
REFERENCES		 Baldev Raj, Practical Non – Destructive Testing, Narosa Publishi 2. Lancaster J.F, Metallurgy of Welding, Abington Publishing,6th E Linnert G. E., 'Welding Metallurgy', Volume I and II, AWS,4thE Mishra. R.S and Mahoney. M.W, Friction Stir Welding and Proce Parmer R.S., "Welding Engineering and Technology", Khanna Publishers,1stEdition New Delhi,2008. Welding Handbook, Volume 2, 7thEdition, American Welding So 	dition, lition, l essing,	1999. 994		

			L	Т	Р	C
	2102MF103	COMPUTER AIDED MANUFACTURING LAB	0	0	4	2
A	IM:			•		
•	To impart the kno	wledge on training the students in the area of CAM				
•	To teach the stude	ents about programming of CNC machines				
•	To train them to u	se the various sensors				
EX	PERIMENTS:					
1.	Exercise on CNC L cycle	athe: Plain Turning, Step turning, Taper turning, Threading, Groo	oving&	cann	ed	
2.		Ailling Machine: Profile Milling, Mirroring, Scaling & canned cyo	cle			
2. 3.		ransducers & PLC: Hall-effect sensor, Pressure sensors, Strain g		LC.I	VDT	
	•	potentiometer, Torque, Temperature & Optical Transducers.		,_		,
	, 0	Tota	al :	60	Hour	
						S
)U	TCOMES:					'S
DU		e to				·s
DU	Students will be able		plicatio	ons		·S
DU	Students will be able	nd grasp the significance of modern machining process and its ap	plicatio	ons		·S
DU	Students will be able CO1 : Understand a through hands-on ex-	nd grasp the significance of modern machining process and its ap	plicatio	ons		·S

		L	Т	Р	С
2102MF104	METAL FORMING AND METAL TESTING LABORATORY	0	0	4	2
AIM:			1		
• To impart practical	knowledge on bulk metal forming and sheet metal forming proc	esses			
OBJECTIVE					
	ts to have an hands on having the basic concepts of metal formin etal forming parameters for a given shape.	g proces	sses a	ndto	
EXPERIMENTS					
1. Determination o	f strain hardening exponent				
	f strain rate sensitivity index				
3. Determination o	f efficiency in water hammer forming				
4. Determination o	f interface friction factor				
5. Study on rolling					
	f torque and force measurement in rolling mill.				
	ing forces on a lathe.				
8. Measurement of	torque on milling machine.				
		TO	ſAL:	60 H	ours
OUTCOMES:					
Students will be ab	le to				
CO1: Understand	and grasp the significance of modern machining process and its				
applications throug	h hands-on experience.				
	selection of machining processes and its process parameters.				
CO3: Express and	perform project related works.				

2101AU001		ENGLISH FOR RESEARCH PAPER WRITING	L	Т	P	С
			2	0	0	0
COURSE OB	JECTIVES:					
	1. Teach how	w to improve writing skills and level of readability				
	2. Tell about	t what to write in each section				
	3. Summariz	ze the skills needed when writing a Title				
	4. Infer the s	skills needed when writing the Conclusion				
	5. Ensure the	e quality of paper at very first-time submission				
MODULE I	INTRODUCTI	ON TO RESEARCH PAPER WRITING	(6 Hou	irs	
lanning and Pr	eparation, Word O	rder, Breaking up long sentences, Structuring Paragraphs and Sentences	Bein	g Coi	ncise	
nd Removing F	Redundancy, Avoid	ling Ambiguity and Vagueness				
MODULE II	PRESENTATIO	ON SKILLS	(б Ног	irs	
Clarifying Who	Did What, Highlig	phting Your Findings, Hedging and Criticizing, Paraphrasing and Plagian	ism, S	Sectio	ns	
of a Paper, Abst	racts, Introduction					
MODULE III	TITLE WRITE	NG SKILLS		б Ног	irs	
•	-	g a Title, key skills are needed when writing an Abstract, key skills are n		when	n	
•		led when writing a Review of the Literature, Methods, Results, Discussion	on,			
Conclusions, Th						
	RESULT WRIT			б Ног		
	•	Methods, skills needed when writing the Results, skills are needed when	n writ	ing th	ie	
		a writing the Conclusions				
MODULE V	VERIFICATIO			б Ног	irs	
Jseful phrases,	checking Plagiaris	m, how to ensure paper is as good as it could possibly be the first- time s	ubmi	ssion		
		Tota	l:	30 H	ours	;
FURTHER R	EADING:	•				
COURSE OU	TCOMES:					
CO1	Understand that	how to improve your writing skills and level of readability				
CO2	Learn about what	t to write in each section				
CO3	Understand the s	kills needed when writing a Title				
CO4	Understand the s	kills needed when writing the Conclusion				
CO5	Ensure the good	quality of paper at very first-time submission				
References:						
1. R. Nishi	ith, Singh AK, "Di	saster Management in India: Perspectives, issues and strategies ""New F	loyal	book	Com	par
2. Sahni, P	Pardeep Et. Al. (Eds	s.)," Disaster Mitigation Experiences And Reflections", Prentice Hall O	f India	ı, Nev	v De	lhi.
3. Goel S. New Delhi		nistration And Management Text And Case Studies", Deep & Deep Publ	icatio	n Pvt	. Ltd	.,

M.E. Manufacturing Engineering | E.G.S. Pillay Engineering College (Autonomous) Regulations 2021 | Approved in VI Academic Council Meeting held on 06.03.2021

2101AU0	02	DISASTER MANAGEMENT	L	Т	Р	С
			2	0	0	0
COURSE OBJE		Cummonize basics of disaster				
	1		ndh	1000	itori	0.12
	2	. Explain a critical understanding of key concepts in disaster risk reduction a response.	ina n	umai	intari	an
	3	. Illustrate disaster risk reduction and humanitarian response policy and pract	tice f	rom	mult	iple
		perspectives.	• •	1		
	4	specific types of disasters and conflict situations.	tical i	elev	ance	ın
	5	I C II				
MODULE I		RODUCTION			ours	5
Disaster: Definiti Difference, Natu		and Significance; Difference between Hazard And Disaster; Natural and Manma d Magnitude	ade D	isast	ers:	
MODULE II	REI	PERCUSSIONS OF DISASTERS AND HAZARDS		6 H	ours	5
Volcanisms, Cyc	lones, Tsun	of Human and Animal Life, Destruction Of Ecosystem. Natural Disas amis, Floods, Droughts And Famines, Landslides And Avalanches, Man-mad l Accidents, Oil Slicks And Spills, Outbreaks Of Disease And Epidemics, Wa	le dis	astei	: Nu	clear
MODULE III		ASTER PRONE AREAS IN INDIA			ours	
		as Prone To Floods and Droughts, Landslides And Avalanches; Areas Prone 7	To Cy			
		Reference To Tsunami; Post-Disaster Diseases and Epidemics)			
MODULE IV		ASTER PREPAREDNESS AND MANAGEMENT			ours	5
		⁷ Phenomena Triggering a Disaster or Hazard; Evaluation of Risk: Application ogical And Other Agencies, Media Reports: Governmental and CommMODU		emo	te	
MODULE V	RIS	KASSESSMENT		6 H	ours	5
Disaster Risk: C	oncept and	Elements, Disaster Risk Reduction, Global and National Disaster Risk Situat	ion.	Tech	niqu	es of
		o-Operation in Risk Assessment and Warning, People's Participation in	Risk	As	sessr	nent.
Strategies for Sur	rvival		1	20.1	T	
FURTHER REA	DINC.	Total:		301	Iour	S
COURSE OUT		-				
		marize basics of disaster				
	,	lain a critical understanding of key concepts in disaster risk reduction and hum	nanita	rian	resp	onse
					•	onse.
	rspectives.	strate disaster risk reduction and humanitarian response policy and practice fro	om m	ultip	le	
	•	cribe an understanding of standards of humanitarian response and practical rele	evano	e in	spec	ific
		ers and conflict situations.				
CO5 A		elop the strengths and weaknesses of disaster management approaches				
1. Goel S. L	., Disaster A	dministration And Management Text And Case Studies", Deep & Deep Public	catior	n Pvt	. Ltd	••
	ai, Singh A	K, "Disaster Management in India: Perspectives, issues and strategies "'NewR	loyal	Boo	k	
Company		"Disaster Mitigation Experiences And Reflections", Prentice Hall OfIndia, N		Jolh:	2001	1
3. Sahni, Pa	uceprt.Al.	, Disaster wingation Experiences And Reflections, Prenuce Hall Offindia, N	ew L	emi	,200	1.

2101AU003		SANSKRIT FOR TECHNICAL KNOWLEDGE	L	Т	Р	C
			2	0	0	0
COURSE OB.	ECTIVES:					-
	1. Illustrate tl	ne basic Sanskrit language				
	2. Recognize	Sanskrit, the scientific language in the world.				
	3. Appraise le	earning of Sanskrit to improve brain functioning.				
	4. Relate San power.	skrit to develop the logic in mathematics, science & other subjects enl	ancing	the	men	ıor
	5. Extract hu	ge knowledge from ancient literature.				
MODULE I	ALPHABETS			6	Ho	urs
Alphabets in Sar	skrit					
MODULE II	TENSES AND S	ENTENCES		6	Ho	urs
Past/Present/Fut	re Tense - Simple S	Sentences				
MODULE III	ORDER AND R	OOTS		6	Но	urs
Order - Introduct	tion of roots					
MODULE IV	SANSKRIT LIT	ERATURE		6	Ho	urs
Technical inform	nation about Sanskri	t Literature				
MODULE V	TECHNICAL C	ONCEPTS OF ENGINEERING		6	Но	urs
Technical conce	ots of Engineering-E	Electrical, Mechanical, Architecture, Mathematics				
		Total	3	0 He	ours	
FURTHER RI	EADING:	-				
COUDEE OU						
COURSE OU	1	· 0 · 1 · 1				
CO1 CO2	Write sentences	sic Sanskrit language				
C02 C03		nd roots of Sanskrit.				
CO4		hical information about Sanskrit literature				
C04		chnical concepts of Engineering				
References:						
	spustakam" – Dr. Vi	shwas, Samskrita-Bharti Publication, New Delhi				
2. "Teach Publicat		rathama Deeksha-Vempati Kutumbshastri, Rashtriya SanskritSanstha	nam, N	ew I	Delh	i

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2101AU004		VALUE EDUCATION	-	L T 2 0	P 0	C 0
COURSE OBJ	ECTIVES:					
	1. Understar	nd value of education and self-development				
	2. Imbibe go	ood values in students				
	3. Let the sh	hould know about the importance of character				
MODULE I				6	Hou	rs
		cial values and individual attitudes. Work ethics, Indian vision o es. Value judgment's	f humanism. Mora	l and no	on-mo	oral
MODULE II				8	Hou	rs
		es. Sense of duty. Devotion, Self-reliance. Confidence, Concentra th, Nationally Patriotism. Love for nature, Discipline	tion. Truthfulness,	Cleanli	iness.	
Personality and and Kindness. friendship. Hap	Avoid fault Thin	opment-Soul and Scientific attitude. Positive Thinking. Integrity king. Free from anger, Dignity of labor. Universal brother h ng, love for truth. Aware of self-destructive habits. Association	ood and religious	unctual tolerar	nce. T	ov Tru
Personality and and Kindness. friendship. Hap saving nature MODULE IV	Avoid fault Thin ppiness vs sufferin	king. Free from anger, Dignity of labor. Universal brother h ng, love for truth. Aware of self-destructive habits. Association	nood and religious n and Cooperation	unctual tolerar Doing	lity, L nce. T g best	ov Tru fc
Personality and and Kindness. friendship. Hap saving nature MODULE IV Character and	Avoid fault Thin ppiness vs sufferin Competence–Holy	king. Free from anger, Dignity of labor. Universal brother h	hood and religious n and Cooperation Science of reincar	unctual tolerar Doing 8 nation.	lity, L nce. T g best Hou Equa	ov Tru fo rs
Personality and and Kindness. friendship. Hap saving nature AODULE IV Character and Nonviolence, H	Avoid fault Thin ppiness vs sufferin Competence–Holy	king. Free from anger, Dignity of labor. Universal brother h ng, love for truth. Aware of self-destructive habits. Association y books vs Blind faith. Self-management and Good health. S	hood and religious n and Cooperation Science of reincar	vunctual tolerar . Doing 8 nation. onesty,	lity, L nce. T g best Hou Equa	ov Fru fo rs lity
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and Kindness. friendship. Hap saving nature MODULE IV Character and Nonviolence, H effectively. FURTHER RE COURSE OUT CO1 CO2	Avoid fault Thin ppiness vs sufferin Competence–Holy Iumility, Role of EADING: FCOMES: Knowledge of se Learn the import Developing the o	king. Free from anger, Dignity of labor. Universal brother h ng, love for truth. Aware of self-destructive habits. Association y books vs Blind faith. Self-management and Good health. S Women. All religions and same message. Mind your Mind - - elf-development tance of Human values	hood and religious n and Cooperation Science of reincard l, Self-control. Ho	vunctual tolerar . Doing 8 nation. onesty,	lity, L nce. T g best Hou Equa Study	ove True fo rs lity

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				onomic rights	s as well as the e	emerg	ence natio	on hood	in the	e earl	у
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MODULE I	HISTORY OF		-		-		institution		Hour	'S	
	g Committee, (Co							0.	noui	5	
MODULE II	PHILOSOPHY	*		STITUTION	•			5	Hour	s	
Preamble, Salie	1				•					5	
MODULE III)F CONSTIT		RICHTS AN	D DUTIES.			5	Hour	PC .	
	ights, Right to Equ					ght to	Freedom				ural
	l Rights, Right to C	• •			-	•			•	Cuit	urai
and Educational	i Rights, Right to C	Constitutional	Kenicules, D		iples of State I (oney,	runuame		ues.		
MODULE IV	ORGANS OF	GOVERNAN	CE:					5	Hour	S	
		· · · 1	Disqualificat	tions Doword	s and Function	ıs. Ex	ecutive	Preside	nt. G	over	nor
Parliament. Co	mposition. Qualit	fications and		LIOHS. FOWERS					,		ю.
	mposition, Qualif isters. Judiciary. A										101,
	mposition, Qualif isters, Judiciary, A										101,
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2101AU006	PEDAGOGY STUDIES		Ļ	L 2	T	P	C
COURSE OBJE	CTIVES:			2	0	0	0
COURSE OBJE	1. Review existing evidence on there view topic to inf	form programmed	design and r	olic	•••		
	2. Making under taken by the DfID, other agencies an		uesign and p	Join	<i>.</i> y		
	3. Identify critical evidence gaps to guide the developm						
	INTRODUCTION AND METHODOLOGY:	ment.				(11.	
MODULE I	I.e., Policy background, Conceptual framework and terminol	1 The sector of	: 1	,		6 Ho	
	eptual framework, Research questions - Overview of method			Juin	icuiu	111, 1	each
IODULE II	THEMATIC OVERVIEW				(6 Ho	urs
Pedagogical prac Teacher educatio	tices are being used by teachers in formal and informal c n.	lassrooms in deve	loping cour	ntrie	s - (Curri	culun
IODULE III	EVIDENCE ON THE EFFECTIVENESS OF PEDAGO	OGICAPRACTIC	CES		(6 Ho	urs
practicum) and the nature of the bod	the in depth stage: quality assessment of included studie the school curriculum and guidance materials best support effective of evidence for effective pedagogical practices - Pedagogi efs and Pedagogic strategies.	ective pedagogy - '	Theory of cl	nang	ge - S	treng	gth an
MODULE IV	PROFESSIONAL DEVELOPMENT					6 Ho	urs
	elopment: alignment with classroom practices and follow up	support - Peer su	pport - Sup	port			
		1 1 1 1	1	11			
	mm MODULEy - Curriculum and assessment - Barriers to I	learning: limited re	esources and	l lar			
IODULE V	RESEARCH GAPS AND FUTURE DIRECTIONS				6	ó Hou	ırs
IODULE V	-				6	ó Hou	ırs
IODULE V	RESEARCH GAPS AND FUTURE DIRECTIONS				resea	ó Hou	urs mpac
IODULE V Research design	RESEARCH GAPS AND FUTURE DIRECTIONS - Contexts – Pedagogy - Teacher education - Curriculum and		semination a		resea	6 Hou irch i	urs mpac
IODULE V	RESEARCH GAPS AND FUTURE DIRECTIONS - Contexts – Pedagogy - Teacher education - Curriculum and		semination a		resea	6 Hou irch i	urs mpac
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IODULE V Research design FURTHER REA COURSE OUTO	RESEARCH GAPS AND FUTURE DIRECTIONS - Contexts – Pedagogy - Teacher education - Curriculum and DING: - COMES: - What pedagogical practices are being used by teachers infor countries? What is the evidence on the effectiveness of these pedagogical	l assessment - Diss	semination a Total: classrooms	ind i	resea cevelo	5 Hou arch in 30 Ho opping	urs mpac ours
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AODULE V Research design FURTHER REA COURSE OUT CO1 CO2	RESEARCH GAPS AND FUTURE DIRECTIONS - Contexts – Pedagogy - Teacher education - Curriculum and - Contexts – Pedagogy - Teacher education - Curriculum and - Contexts – Pedagogy - Teacher education - Curriculum and - Comes: - What pedagogical practices are being used by teachers infor countries? What is the evidence on the effectiveness of these pedagogic population of learners? How can teacher education (curriculum and practicum) and best support effective pedagogy?	l assessment - Diss rmal and informal cal practices, in wl	semination a Total: classrooms hat condition	ind i	resea evelo	5 Hou rch i 30 Ho oping vith v	urs mpac ours
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AODULE V Research design FURTHER REA COURSE OUTO CO1 CO2 CO3 REFERENCES 1. Ackers J, 2. Agrawal N 36(3):361 3. Akyeamp (MUSTE) 4. Akyeamp	RESEARCH GAPS AND FUTURE DIRECTIONS - Contexts – Pedagogy - Teacher education - Curriculum and - Contexts – Pedagogy - Teacher education - Curriculum and - DING: - - COMES: - What pedagogical practices are being used by teachers infor countries? - What is the evidence on the effectiveness of these pedagogic population of learners? How can teacher education (curriculum and practicum) and best support effective pedagogy? - HardmanF (2001) Classroom interaction in Kenyan primary M (2004)Curricular reform in schools: The importance of eva -379. ong K (2003) Teacher training in Ghana-does it count? Multi	d assessment - Diss rmal and informal cal practices, in wl the school curricu schools, Compare, aluation, Journal of i-site teacher educa	semination a Total: classrooms hat condition lum and gui , 31(2): 245- f Curriculun ation researc g of basic m	in d in d ns, a dan - 26 - 26 - 5tu ch pr aths	evelo and v ce m 1. rojec	5 Hou rrch in 30 Ho pping pping vith v ateria	urs mpac ours what als
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																2	2	0	0	0
COURSE OBJ	ECTIVES:																			
	1. To ac	chiev	eve ov	verall	heal	lth of	fbody	y and	d mi	nd										
	2. To ov	overco	come	stress	s															
MODULE I																			10 H	Iours
Eight parts of yog	a.(Ashtanga))																		
MODULE II																			10 H	Iours
Yam and Niyam -	Do's and Dor	on't's	's in li	ife - i)) Ahi	insa,	satya	a, ast	theya	a, bra	amha	acha	rya a	nd apa	arigrah	a,				
MODULE III																			10 H	Iours
Asan and Pranaya effects-Types of p		yog p	pose	s and	their	r ben	nefits	for 1	mind	1&1	body	- Re	egula	rizatio	on ofbr	eathir	ig te	echnic	ques a	nd its
															Т	'otal:			30 H	ours
FURTHER RE	ADING:											-								
COURSE OUT	COMES:																			
CO1	Develop hea	althy	iy min	nd in a	a hea	althy	body	y thu	ıs im	prov	ving	socia	al hea	alth al	SO					
CO2	Improve eff	ficier	ency																	
REFERENCES	:																			
1. Yogic As	anas for Grou	up Ta	Farini	ng-Pa	art-I"	':Jan	ardar	n Sw	vami	Yog	ga bh	nyasi	Man	idal, N	lagpur					
2. Rajayoga Kolkata	or conquerin	ng the	he Int	ernal	Natu	ure"	by Sv	wam	ni Viv	veka	ananc	da, A	dvai	ta Ash	nrama	(Publi	cati	on De	epartn	nent),

210141000		PERSONALITY DEVELOPMENT THROUGH LIFE	L	T	Р	С
2101AU008		ENLIGHTENMENT SKILLS	2	0	0	0
COURSE OBJE	ECTIVES:				<u> </u>	
	1. To learn	to achieve the highest goal happily				
	2. To becc	me a person with stable mind, pleasing personality and determination				
	3. To awa	ken wisdom in students				
MODULE I				10 H	lour	'S
	-	ent of personality - Verses- 19,20,21,22 (wisdom) - Verses- 29,31,32 (prio erses- 52,53,59 (dont's) - Verses- 71,73,75,78 (do's)	le & h	erois	m) -	_
MODULE II				10 H	lour	S
		l duties - Shrimad Bhagwad Geeta: Chapter 2-Verses 41, 47,48 - Chapter 23, 35 - Chapter 18-Verses 45, 46, 48.	3- Ve	rses	13, 2	21,
MODULE III				10 H	lour	'S
	of role model - s	Shrimad Bhagwad Geeta: Chapter2-Verses 56, 62, 68 Chapter 12 -Verses hrimad bhagwad geeta - Chapter2- Verses 17, Chapter 3-Verses 36,37,42 erses 37,38,63		, 15, hapte		7,
	1	Total:		30 H	our	s
FURTHER RE	ADING:	-				
COURSE OUT	COMES:					
CO1	Study of Shrin highest goal in	ad-Bhagwad-Geeta will help the student in developing his personality an life	d achi	eve t	he	
CO2	The person wh	o has studied Geeta will lead the nation and mankind to peace and prospe	rity			
CO3	Study of Neet	is hatakam will help in developing versatile personality of students.				
REFERENCES	:					
1. Gopinath New Dell	•	krit Sansthanam P, Bhartrihari's Three Satakam, Niti- sringar-vairagya,				
2. Swami Sv	warupananda , S	rimad Bhagavad Gita, Advaita Ashram, Publication Department, Kolkata,	2016.			

3101 A TTOOP					L	Т	Р	C
2101AU009			UNNAT BHAI	RAT ABHIYAN	2	0	0	0
COURSE OB	JECTIVES:							
		•		vision of transformation	•		-	
	-	s by leveragin	g knowledge instit	utions to help build the	ne architectu	re of a	an Inclu	isiv
	India.	• • • • • • • • •			1	· .	1	• .1
			•	to enable higher educa				
			g sustainable grow	g development challen th.	iges and ev	olving	approp	riate
	3. It also a	ims to create	a virtuous cycle b	etween society and an	inclusive ac	ademio	syster	n by
	providing	g knowledge a	nd practices for en	nerging professions and	l to upgrade	the ca	pabilitie	es o
	both the	public and the	private sectors in re	esponding to the develop	pment needs	of rura	l India	
MODULE 1							10 Hou	rs
	l olistic developme	nt of a village -	- Economic Social	, Human, Governance, l	Basic Ameni	ies En	vironm	enta
	-			arat Abhiyin. Expediti				
-							-	nous
	l development wi	th effective sup				uildin	g capaci	
	-		pport from professi	onal institutes of higher	education. I			ity i
institutes of Hig	ther Education for	research, train	pport from professi	onal institutes of higher nt of technologies relev	education. I			ity i
institutes of Hig	ther Education for	research, train	pport from professiing and developme	onal institutes of higher nt of technologies relev	education. I	al need	s, espec	ity in all
institutes of Hig	ther Education for	research, train	pport from professiing and developme	onal institutes of higher nt of technologies relev	education. I	al need		ity ii ally
institutes of Hig those of rural In MODULE 2	ther Education for adia. Creating the	research, train Requisite Struc	oport from professi ing and developme cture to Cope with t	onal institutes of higher nt of technologies relev	education. I ant to nation	al need	s, espec	ity i riall
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